Situation with industry

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Let me remind you the last process for mass production

PCB + readout strips

50um Kapton + resistive strips

3



50um Kapton + resistive strips



50um Kapton + resistive strips

50um Kapton + resistive strips



50um Kapton + resistive strips



Micromegas final assembly:





PCB + readout strips

• <u>ELTOS</u>

• Boards of 2m x 0.5m have been already produced

•Quote request for 1200m2 (2.25m x 0.5m) on going

•1.2m x 0.5m in production for MSW test

• <u>ELVIA</u>

•Boards of 2m x 0.5m have been already produced

•2 Boards LSBB project 1.2m x 0.5m in production (2D read-out)

•Quote request for large volume soon

• Triangle labs:

•Boards of 2m x 0.5m have been already produced

•Quote request for large volume soon

Resistive deposition

•<u>Charbonney</u>

- •Swiss company near CERN doing screen printing
- •Printing $1m \ge 0.5m$ resistive strips $\rightarrow OK$
- •Max possible size: 1.5m x 0.9m
- •Mass Production \rightarrow OK
- •MSW in production
- ATLAS MAMMA , LSBB and many small detectors have been produced
- •Waiting for large volume quote

•<u>ELVIA</u>

•1.2m x 0.5m LSBB in production (Screen printing)

•<u>ELTOS</u>

- •1.2 x 0.5m MSW in production (Screen printing)
- •2.3m x 0.5m possible
- We are waiting for large volume quote

•<u>Raytech</u>

- Japanese company (Ochi Atsuhiko contact)
- Vacuum deposited resistive layers (lift off technique)
- •MSW in production





Wikipedia PECVD

<u>Large size gluing</u>



•<u>MDT</u>

- •Italian company having an extra large Isostatic press (similar process used at CERN)
- •Press gluing capability 4.2m x 1.6m \rightarrow to be tested
- •Mass production \rightarrow seems OK
- •Quotes for large volume not yet asked
- •We should organize a visit and probably make the MSW prototypes



• <u>ELVIA</u>

• They have an Autoclave with the correct dimension.



Pillar creation



•<u>ELTOS</u>

•1.2m x 0.5m MSW Micromegas in production

•Quote for 1200m2 requested

•<u>ELVIA</u>

- •LSBB 1.2m x 0.5m real BULK in production
- •Quote for large volume still to be sent.

• Triangle Labs

•No request submitted up to now

Mesh stretching



•<u>Seritec</u>

- •Swiss company near CERN stretching meshes
- •Stretching $2m \times 1m$ mesh $\rightarrow OK$
- •Max possible size: 3.2m x 2.2m
- •Mass production $\rightarrow OK$
- •We are studying the received quotes for 1200m2

Registration

• Optical fiducial (ultimate precision)

•RASMASKs directly on the boards

•A few um error due to the photolithographic mask.

• Mechanical fiducial (less precise due to assembly steps)

- •Precise CCD or X-ray drilling machine
- •Drill perfectly in the middle of a pattern.
- •Triangle Labs have such machine (+/-15um error claimed by the machine producer : PLURITEC)
- •This machine can drill and mill on 2.5m x 0.6m

PCB production considerations

- PCB size: 0.5 x 2.4 m², the same for all boards
 - Combine two small boards into one PCB; reduces # of PCB layouts
 - 24 different PCB layouts
 - Number of PCBs (w/o) spares: 1536



- Production could be split between two or three producers
- PCB production in four steps
 - 1. Etching of readout pattern
 - 2. Gluing of KAPTON foil with resistive strips (produced in Japan)
 - 3. Making of pillars
 - 4. Cutting and drilling
- All steps could be done by different industries or some by the same
- Three or four different call for offers

PCB production time line

- MM construction start: 2015
- PCB production contracts should be signed in fall 2014
- First boards to be delivered in Feb 2015
- Typical output: 8 boards/day
 - 3 4 months if split b/w three producers
 - 6 months if two producers

PCB production - open questions

- What about spares?
- What about the drift electrodes?
 - Cu-clad PCBs if so, who does them?
 - Conducting paint (spray ?)
 - Cu foil ?
 - Other ...

PCB production – Module 0

- Use PCBs for Module 0 to qualify potential production sites & procedures
 - Split orders into small orders in different companies (if possible)
 - Contracts for full production will not yet be signed
- Module 0 orders have to be placed in April 2014 to have PCBs for Module 0 construction in June/July
- PCB layout/design has to be frozen in March
- Qualification of Kapton glueing and pillar deposition on full-size PCBs to be done b/w now and February 2014

<u>Thank you</u>